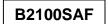


NOT RECOMMENDED FOR NEW DESIGN USE B2100AF





2.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

VRRM (V)	lo (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (μA) @ +25°C
100	2	0.79	10

Description and Applications

The B2100SAF is a 2A 100V single rectifier packaged in the low profile SMAF package. Providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- · Recirculating Diode

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-Temperature Reverse Leakage; Increased Reliability Against Thermal Runaway Failure in High Temperature Operation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (©3)
- Polarity: Cathode Band
 - Weight: 0.036 grams (Approximate)



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
B2100SAF-13	SMAF	10,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

SMAF



Dil = Manufacturer's Marking
B2100SAF = Product Type Marking Code
YWW = Date Code Marking
Y = Last Digit of Year (ex: 9 for 2019)
WW = Week Code (01 to 53)



Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm Vrwm Vrm	100	٧
Average Rectified Output Current	lo	2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	60	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	RθJA	90	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	Rejc	30	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF	1	0.74 0.60	0.79	r \/	IF = 2A, T _J = +25°C IF = 2A, T _J = +125°C
Leakage Current (Note 6)	IR	<u>-</u>	_	10 2		V _R = 100V, T _J = +25°C V _R = 100V, T _J = +125°C
Typical Capacitance	Ст	-	93		pF	V _R = 4.0V, f = 1MHz

Notes:

- 5. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad. 6. Short duration pulse test used to minimize self-heating effect.





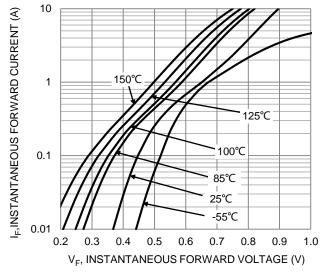


Figure 1. Typical Forward Characteristics

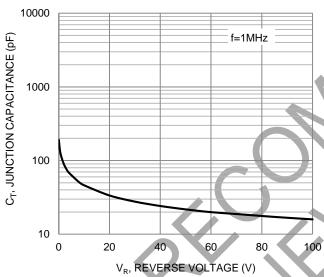


Figure 3. Typical Junction Capacitance

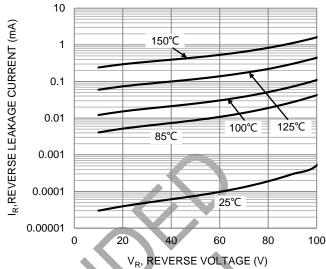


Figure 2. Typical Reverse Characteristics

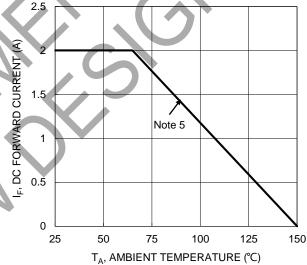


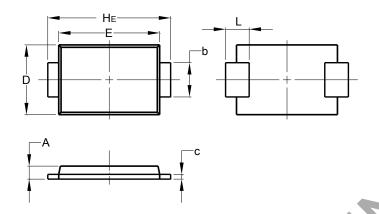
Figure. 4, DC Forward Current Derating



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMAF

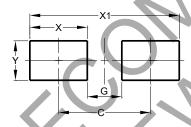


SMAF			
Dim	Min	Max	
Α	0.90	1.10	
b	1.25	1.65	
С	0.10	0.40	
D	2.25	2.95	
E	3.95	4.60	
HE	4.80	5.60	
L	0.50	1.50	
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMAF



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70



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